

## **Excellent Integrated System Limited**

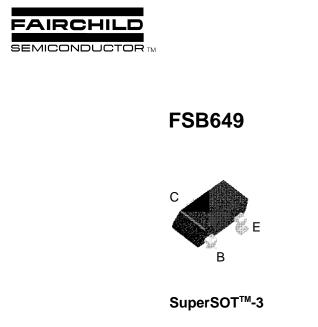
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Fairchild Semiconductor FSB649

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### **NPN Low Saturation Transistor**

These devices are designed with high current gain and low saturation voltage with collector currents up to 3A continuous. Sourced from Process NC.

#### Absolute Maximum Ratings\* TA = 25°C unless otherwise noted

Symbol	Parameter	FSB649	Units
V <sub>CEO</sub>	Collector-Emitter Voltage	25	V
Vсво	Collector-Base Voltage	35	V
V <sub>EBO</sub>	Emitter-Base Voltage	5	V
I <sub>C</sub>	Collector Current - Continuous	3	А
T <sub>J,</sub> T <sub>stg</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C

\*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

1) These ratings are based on a maximum junction temperature of 150°C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

#### Thermal Characteristics T<sub>A = 25°C unless otherwise noted</sub>

Symbol	Characteristic	Мах	Units
		FSB649	
PD	Total Device Dissipation	500	mW
R <sub>0JA</sub> Thermal Resistance, Junction to Ambient		250	°C/W

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FSB649



Symbol	Parameter	Test Conditions	Min	Max	Units
OFF CHAI	RACTERISTICS				
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	I <sub>C</sub> = 10 mA	25		V
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	I <sub>C</sub> = 100 μA	35		V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	I <sub>E</sub> = 100 μA	5		V
Ісво	Collector Cutoff Current	V <sub>CB</sub> = 30 V V <sub>CB</sub> = 30 V, T <sub>A</sub> =100°C		100 10	nA uA
I <sub>EBO</sub>	Emitter Cutoff Current	$V_{EB} = 4V$		100	nA
h <sub>FE</sub>	ACTERISTICS* DC Current Gain	$I_{C} = 50 \text{ mA}, V_{CE} = 2 \text{ V}$ $I_{C} = 1 \text{ A}, V_{CE} = 2 \text{ V}$ $I_{C} = 2 \text{ A}, V_{CE} = 2 \text{ V}$ $I_{C} = 6 \text{ A}, V_{CE} = 2 \text{ V}$	70 100 75 15	300	-
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	$I_{C} = 1 \text{ A}, I_{B} = 100 \text{ mA}$ $I_{C} = 3 \text{ A}, I_{B} = 300 \text{ mA}$		300 600	mV
V <sub>BE(sat)</sub>	Base-Emitter Saturation Voltage	I <sub>C</sub> = 1 A, I <sub>B</sub> = 100 mA		1.25	V
V <sub>BE(on)</sub>	Base-Emitter On Voltage	I <sub>C</sub> = 1 A, V <sub>CE</sub> = 2 V		1	V
	GNAL CHARACTERISTICS				
	Output Capacitance	V <sub>CB</sub> = 10 V, I <sub>E</sub> = 0, f = 1MHz		50	pF
fT	Transition Frequency	$I_{C} = 100 \text{ mA}, V_{CE} = 5 \text{ V}, \text{ f} = 100 \text{ mHz}$	150		-
*Pulse Test: F	Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%				

# FSB649

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fsb649.lwpPrNC revA



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